DECLARATION FOR PATENT APPLICATION (JOINT OR SOLE) (Under 37 CFR § 1.63; with Power of Attorney)

FROMMER LAWRENCE & HAUG LLP

FLH File No. 450100-04708

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name,
I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first
and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is
sought on the invention ENTITLED:

ENCRYPTION LEVEL INDICATOR CALCULATION METHOD AND COMPUTER PROGRAM *** A stateched hereto.** *** was filed on as Application Serial No with amendment(s) through	sought on the invention Entitles.					
## is attached hereto. ## was filed on ## as Application Serial No. ## with amendment(s) through ## (if applicable, give dates). I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above. I acknowledge the duty to disclose to the United States Patent and Trademark Office all information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations, Sec. 1.56. I hereby claim foreign priority benefits under Title 35, United States Code, § 119 of any foreign applications or patent or inventor's certificate hereign after the between the patent of the priority of the patent or inventor's certificate hereign attentions that the state patent of the priority of the patent or inventor's certificate hereign attentions on separate page! Prior Foreign Application(s) Number: **Number:** **Diaph *	ENCRYPTION LEVEL INDIC	CATOR CALCULATION	METHOD AND	COMPUTER	PROGRAM	L
with amendment(s) through	the specification of which					
I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above. I hereby claim foreign priority benefits under 11(1), 27, code of Federal Regulations, Sec. 1.56. I hereby claim foreign priority benefits under 11(1), 37, code of Federal Regulations, Sec. 1.56. I hereby claim foreign priority benefits under 11(1), 37, code of Federal Regulations, Sec. 1.56. I hereby claim foreign priority benefits under 11(1), 37, code of Federal Regulations, Sec. 1.56. I hereby claim foreign priority benefits under 11(1), 37, code of Federal Regulations, on separate pagel: Prior Foreign Application(s) I tits additional applications on separate pagel: Priority Claimed: Prior Localization for patent or sec. 2002-230270 Country: Japan I hereby claim the benefit under Ifitle 35, United States Code, \$ 120 of any United States application (s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Ifitle 35, United States code \$ 112, I acknowledge the duty to disclose to the United States Patent and Trademark Office all information known to me to be material to patentability as defined in Ifitle 37, Code of Federal Regulations, Sec. 1.56, which became available between the filing date of the prior application and the national or PCI international filing date of this application: Prior U.S. Application(s) (List additional applications on separate pagel: Applin. Ser. Number: Applin. Ser. Number: Prior U.S. Application(s) (List additional applications on separate pagel: Applin. Ser. Number: Application, to make alternations and manchements therefore to the foreign of the prior application of the research of the prior application and the national or PCI international and international applications thereof, to receive the Patent, and to transact all business in the Patent and Tra						
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the claims, as amended by any amendment referred to above. I acknowledge the duty to disclose to the United States Patent and Trademark Office all information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations, Sec. 1.56. I hereby claim foreign priority benefits under Title 35, United States Code, 8 19 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed: Prior Foreign Application(s)	with amendment(s) through		(if a	pplicable, g	ive dates)	•
below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code § 112, I acknowledge the duty to disclose to the United States Patent and Trademark Office all information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations, Sec. 1.56, which became available between the filing date of the prior application and the national or PCT international filing date of this application: Prior U.S. Application(s) [List additional applications on separate page]: Appln. Ser. Number: Filed (Day/Month/Year): I hereby appoint WILLIAM S. FROMMER, Registration No. 25,506, and DENNIS M. SMID, Registration No. 34,930 or their duly appointed associate, my attorneys, with full power of substitution and revocation, to prosecute this application, to make alterations and mendments therein, to file continuation and divisional applications thereof, to receive the Patent, and to transact all business in the Patent and Trademark Office and in the Courts in connection therewith, and specify that all communications about the application are to be directed to the following correspondence address: WILLIAM S. FROMMER, Esq	the claims, as amended by any amendment reformaterial to patentability as defined I hereby claim foreign priority ben for patent or inventor's certificate listed inventor's certificate having a filing date Prior Foreign Application(s) [line Number: Counterior Number: Number Num	erred to above. to the United States Pain Title 37, Code of Fe efits under Title 35, to below and have also id before that of the app st additional application	ntent and Tradema deral Regulation Inited States Cod entified below a lication on whic ons on separate led (Day/Month/Y	ark Office al s, Sec. 1.56 de, § 119 of my foreign a ch priority i pagel: <u>P</u> ear):	l informat any foreig pplication s claimed: riority Cla	ion known to me n application(s) for patent or nimed:
or their duly appointed associate, my attorneys, with full power of substitution and revocation, to prosecute this application, to make alterations and amendments therein, to file continuation and divisional applications thereof, to receive the Patent, and to transact all business in the Patent and Trademark Office and in the Courts in connection therewith, and specify that all communications about the application are to be directed to the following correspondence address: WILLIAM S. FROMMER	below and, insofar as the subject matter of States application in the manner provided by duty to disclose to the United States Patern patentability as defined in Title 37, Code of date of the prior application and the nation Prior U.S. Application(s) [list add	each of the claims of y the first paragraph of t and Trademark Office of Federal Regulations, nal or PCT internationa ditional applications o	this application f Title 35, Unit all information Sec. 1.56, whic l filing date of n separate page]	n is not disc ed States Co known to me th became ava this applic	losed in the de § 112, to be materiallable between	he prior United I acknowledge the rial to ween the filing
C/o FROMMER LAWRENCE & HAUG LLP 745 Fifth Avenue to the attention of: New York, New York 10151 I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon. INVENTOR(S): Signature: Tokyo, Japan Signature: Full name of 2nd joint inventor (if any): Residence: Citizenship: Date: Full name of 3rd joint inventor (if any): Residence: Citizenship: Date: Full name of 3rd joint inventor (if any): Residence: Citizenship:	or their duly appointed associate, my attornapplication, to make alterations and amendmereceive the Patent, and to transact all bus therewith, and specify that all communications.	neys, with full power of ents therein, to file of iness in the Patent and	f substitution a ontinuation and Trademark Office	and revocation divisional a ce and in the	n, to pros pplication Courts in	ecute this s thereof, to connection
745 Fifth Avenue New York, New York 10151 I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon. INVENTOR(S): Signature: Full name of sole or first inventor: Shoji KANAMARU Tokyo, Japan Japan Signature: Full name of 2nd joint inventor (if any): Residence: Citizenship: Date: Full name of 3rd joint inventor (if any): Residence: Citizenship: Date: Date: Date: Citizenship:				phone calls	to:	
I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon. INVENTOR(S): Signature:						
information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon. INVENTOR(S): Signature: Full name of sole or first inventor: Shoji KANAMARU Tokyo, Japan Japan Signature: Full name of 2nd joint inventor (if any): Residence: Citizenship: Signature: Full name of 3rd joint inventor (if any): Residence: Citizenship: Date: Full name of 3rd joint inventor (if any): Residence: Citizenship:	New York, New York 10151					
Full name of 2nd joint inventor (if any): Residence: Citizenship: Signature: Date: Full name of 3rd joint inventor (if any): Residence: Citizenship:	information and belief are believed to be t willful false statements and the like so man Title 18 of the United States Code and that or any patent issued thereon. INVENTOR(S): Signature: Full name of sole or first inventor: Residence:	rue; and further that t de are punishable by fi such willful false sta Shoji KANAMARU Tokyo, Japan	hese statements ne or imprisonme tements may jeop	were made wi ent, or both, pardize the v	th the know under Sec	wledge that tion 1001 of
Residence: Citizenship: Signature: Date: Full name of 3rd joint inventor (if any): Residence: Citizenship:			Da	ite:		
Full name of 3rd joint inventor (if any): Residence: Citizenship:	Residence:					
[Similarly list additional inventors on separate page]	Full name of 3rd joint inventor (if any): Residence:		Da	ete:		
Post Office Address(es) of inventor(s): [if all inventors have the same post office address] Note: A post office address must be provided for each inventor. Sony Corporation 7-35 Kitashinagawa 6-chome Shinagawa-Ku, Tokyo 141, Japan	[if all inventors have the same post office	address]	7-35 Kitashinag	awa 6-chome	pan	